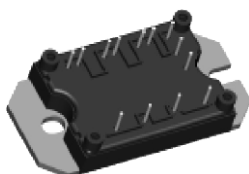


Three Phase Inverter Module in MTP Package 1200 V NPT IGBT and HEXFRED® Diodes, 15 A


MTP

FEATURES

- Generation 5 NPT 1200 V IGBT technology
- HEXFRED® diode with ultrasoft reverse recovery
- Very low conduction and switching losses
- Optional SMT thermistor (NTC)
- Aluminum oxide DBC
- Very low stray inductance design for high speed operation
- Short circuit 10 μ s
- Square RBSOA
- Operating frequencies 8 kHz to 60 kHz
- UL approved file E78996 
- Compliant to RoHS directive 2002/95/EC
- Designed and qualified for industrial level


RoHS
COMPLIANT

PRODUCT SUMMARY

V_{CES}	1200 V
$V_{CE(on)}$ typical at $V_{GE} = 15$ V	2.51 V
I_C at $T_C = 100$ °C	15 A
t_{sc} at $T_J = 150$ °C	> 10 μ s

BENEFITS

- Optimized for inverter motor drive applications
- Low EMI, requires less snubbing
- Direct mounting to heatsink
- PCB solderable terminals
- Very low junction to case thermal resistance

ABSOLUTE MAXIMUM RATINGS

PARAMETER	SYMBOL	TEST CONDITIONS	MAX.	UNITS
Collector to emitter voltage	V_{CES}		1200	V
Continuous collector current	I_C	$T_C = 25$ °C	30	A
		$T_C = 100$ °C	15	
Pulsed collector current	I_{CM}		60	
Peak switching current	I_{LM}		60	
Diode continuous forward current	I_F	$T_C = 100$ °C	15	
Peak diode forward current	I_{FM}		30	
Gate to emitter voltage	V_{GE}		± 20	V
RMS isolation voltage	V_{ISOL}	Any terminal to case, $t = 1$ min	2500	
Maximum power dissipation (including diode and IGBT)	P_D	$T_C = 25$ °C	187	W
		$T_C = 100$ °C	75	

ELECTRICAL SPECIFICATIONS (T _J = 25 °C unless otherwise specified)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Collector to emitter breakdown voltage	V _{(BR)CES}	V _{GE} = 0 V, I _C = 250 μA	1200	-	-	V
Temperature coefficient of V _{(BR)CES}	ΔV _{(BR)CES} /ΔT _J	V _{GE} = 0 V, I _C = 1 mA	-	1.11	-	V/°C
Collector to emitter voltage	V _{CE(on)}	V _{GE} = 15 V, I _C = 15 A	-	2.51	2.70	V
		V _{GE} = 15 V, I _C = 30 A	-	3.36	3.66	
		V _{GE} = 15 V, I _C = 15 A, T _J = 125 °C	-	2.94	3.16	
		V _{GE} = 15 V, I _C = 30 A, T _J = 125 °C	-	4.12	4.46	
Gate threshold voltage	V _{GE(th)}	I _C = 250 μA	4	-	6	
Temperature coefficient of threshold voltage	ΔV _{GE(th)} /ΔT _J	V _{CE} = V _{GE} , I _C = 1 mA	-	- 10	-	mV/°C
Forward transconductance	g _{fe}	V _{CE} = 25 V, I _C = 15 A	-	12	-	S
Collector to emitter leaking current	I _{CES}	V _{GE} = 0 V, V _{CE} = 1200 V	-	-	250	μA
		V _{GE} = 0 V, V _{CE} = 1200 V, T _J = 125 °C	-	-	1000	
Diode forward voltage drop	V _{FM}	I _F = 15 A, V _{GE} = 0 V	-	2.13	2.58	V
		I _F = 30 A, V _{GE} = 0 V	-	2.70	3.33	
		I _F = 15 A, V _{GE} = 0 V, T _J = 125 °C	-	2.27	2.75	
		I _F = 30 A, V _{GE} = 0 V, T _J = 125 °C	-	3.06	3.76	
Gate to emitter leakage current	I _{GES}	V _{GE} = ± 20 V	-	-	± 250	nA

SWITCHING CHARACTERISTICS (T _J = 25 °C unless otherwise specified)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Total gate charge (turn-on)	Q _g	I _C = 15 A V _{CC} = 600 V V _{GE} = 15 V	-	98	146	nC
Gate to emitter charge (turn-on)	Q _{ge}		-	12	17	
Gate to collector charge (turn-on)	Q _{gc}		-	46	69	
Turn-on switching loss	E _{on}	I _C = 15 A, V _{CC} = 600 V, V _{GE} = 15 V R _g = 10 Ω, L = 500 μH, T _J = 25 °C Energy losses include tail and diode reverse recovery	-	0.990	1.485	mJ
Turn-off switching loss	E _{off}		-	0.827	1.241	
Total switching loss	E _{ts}		-	1.817	2.726	
Turn-on switching loss	E _{on}	I _C = 15 A, V _{CC} = 600 V, V _{GE} = 15 V R _g = 10 Ω, L = 500 μH, T _J = 125 °C Energy losses include tail and diode reverse recovery	-	1.352	2.028	mJ
Turn-off switching loss	E _{off}		-	1.138	1.707	
Total switching loss	E _{ts}		-	2.490	3.735	
Turn-on delay time	t _{d(on)}	I _C = 15 A, V _{CC} = 600 V, V _{GE} = 15 V L = 500 μH, L _S = 100 nH R _g = 10 Ω, T _J = 125 °C	-	95	143	ns
Rise time	t _r		-	18	27	
Turn-off delay time	t _{d(off)}		-	134	200	
Fall time	t _f		-	227	341	
Reverse BIAS safe operating area	RB SOA	T _J = 150 °C, I _C = 60 A R _g = 10 Ω, V _{GE} = 15 V to 0	Fullsquare			
Short circuit safe operating area	SC SOA	V _{CC} = 600 V, V _{GE} = + 15 V to 0 T _J = 150 °C, V _P = 1200 V, R _g = 10 Ω	10	-	-	μs
Input capacitance	C _{ies}	V _{GE} = 0 V V _{CC} = 30 V f = 1 MHz	-	1302	1953	pF
Output capacitance	C _{oes}		-	717	1076	
Reverse transfer capacitance	C _{res}		-	38	57	
Diode reverse recovery energy	E _{rec}	I _C = 15 A, V _{CC} = 600 V, V _{GE} = 15 V L = 500 μH, L _S = 100 nH R _g = 10 Ω, T _J = 125 °C	-	819	-	μJ
Diode reverse recovery time	t _{rr}		-	96	-	ns
Diode peak reverse current	I _{rr}		-	35	-	A

**THERMISTOR SPECIFICATIONS (T CODE ONLY)**

PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Resistance	R_0 ⁽¹⁾	$T_0 = 25\text{ }^\circ\text{C}$	-	30	-	k Ω
Sensitivity index of the thermistor material	β ⁽¹⁾⁽²⁾	$T_0 = 25\text{ }^\circ\text{C}$ $T_1 = 85\text{ }^\circ\text{C}$	-	4000	-	K

Notes

⁽¹⁾ T_0 , T_1 are thermistor's temperatures

⁽²⁾ $\frac{R_0}{R_1} = \exp\left[\beta\left(\frac{1}{T_0} - \frac{1}{T_1}\right)\right]$

THERMAL AND MECHANICAL SPECIFICATIONS

PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Operating junction temperature range	T_J		- 40	-	150	$^\circ\text{C}$
Storage temperature range	T_{Stg}		- 40	-	125	
Junction to case	IGBT		-	-	1.1	$^\circ\text{C/W}$
	Diode		-	-	1.7	
	Module		-	0.50	-	
Case to sink per module	R_{thCS}	Heatsink compound thermal conductivity = 1 W/mK	-	0.1	-	
Mounting torque			-	-	4	Nm
Weight			-	65	-	g

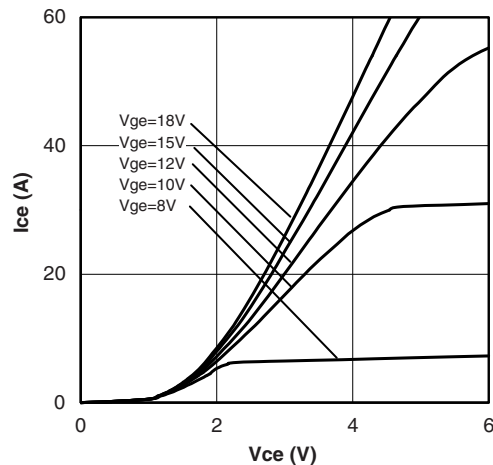


Fig. 1 - Typical Output Characteristics
 $T_J = 25\text{ }^\circ\text{C}$

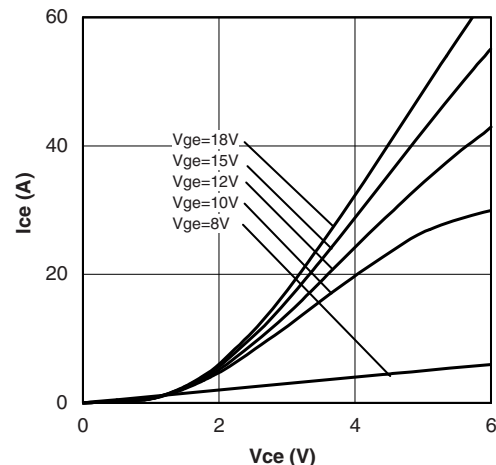


Fig. 2 - Typical Output Characteristics
 $T_J = 125\text{ }^\circ\text{C}$

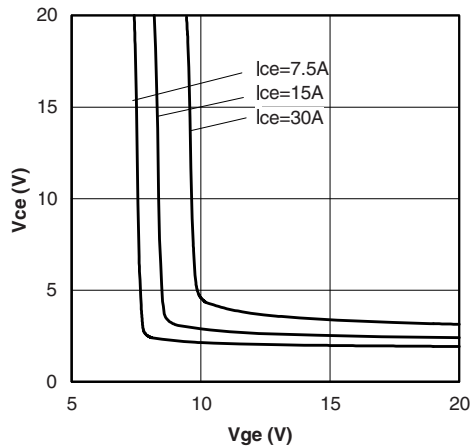


Fig. 3 - Typical V_{CE} vs. V_{GE}
 $T_J = 25^\circ\text{C}$

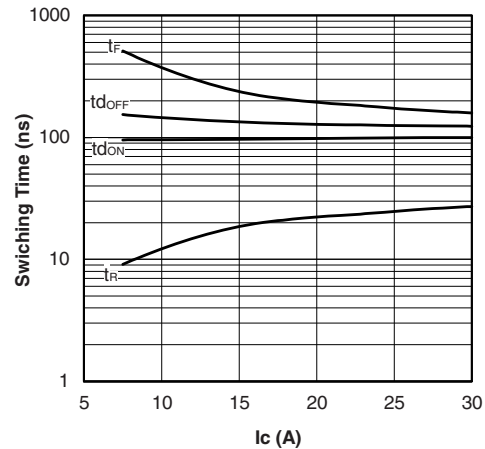


Fig. 6 - Typical Switching Time vs. I_C
 $T_J = 125^\circ\text{C}$, $L = 500\ \mu\text{H}$, $V_{CE} = 600\ \text{V}$
 $R_g = 10\ \Omega$; $V_{GE} = 15\ \text{V}$

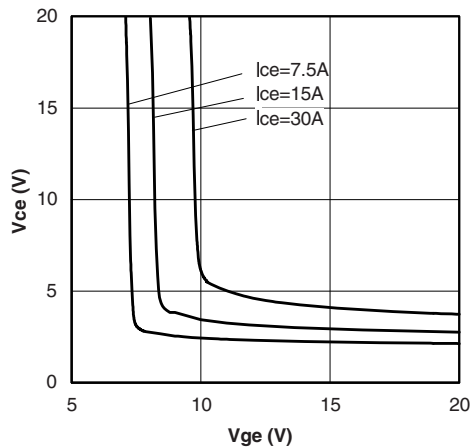


Fig. 4 - Typical V_{CE} vs. V_{GE}
 $T_J = 125^\circ\text{C}$

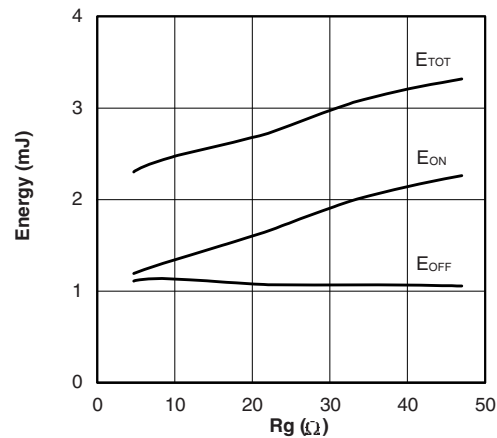


Fig. 7 - Typical Energy Loss vs. R_g
 $T_J = 125^\circ\text{C}$, $L = 500\ \mu\text{H}$, $V_{CE} = 600\ \text{V}$
 $I_C = 15\ \text{A}$; $V_{GE} = 15\ \text{V}$

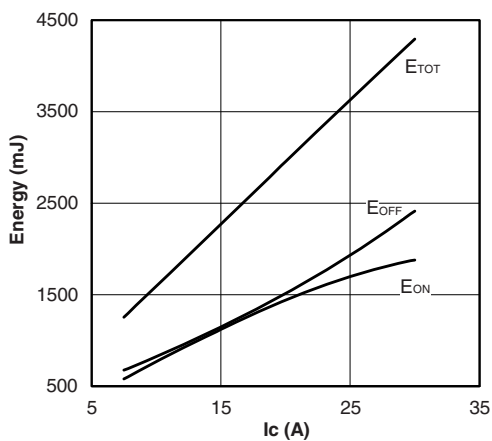


Fig. 5 - Typical Energy Loss vs. I_C
 $T_J = 125^\circ\text{C}$, $L = 500\ \mu\text{H}$, $V_{CE} = 600\ \text{V}$
 $R_g = 10\ \Omega$; $V_{GE} = 15\ \text{V}$

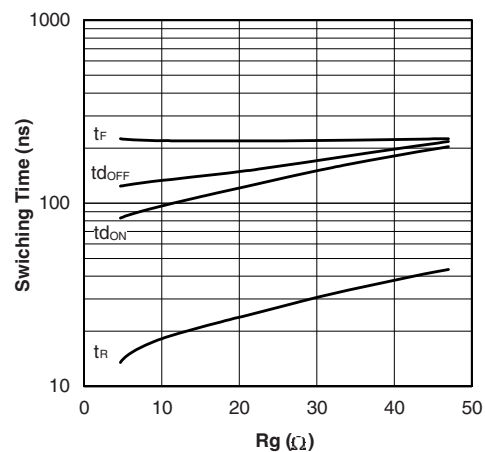


Fig. 8 - Typical Switching Time vs. R_g
 $T_J = 125^\circ\text{C}$, $L = 500\ \mu\text{H}$, $V_{CE} = 600\ \text{V}$
 $I_C = 15\ \text{A}$; $V_{GE} = 15\ \text{V}$

Three Phase Inverter Module in MTP Package Vishay Semiconductors

1200 V NPT IGBT and HEXFRED® Diodes, 15 A

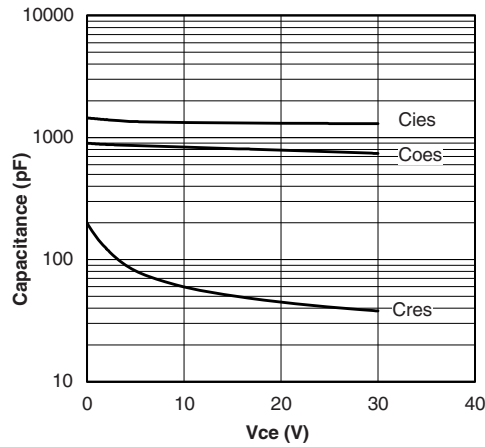


Fig. 9 - Typical Capacitance vs. V_{CE}
 $V_{GE} = 0 \text{ V}$; $f = 1 \text{ MHz}$

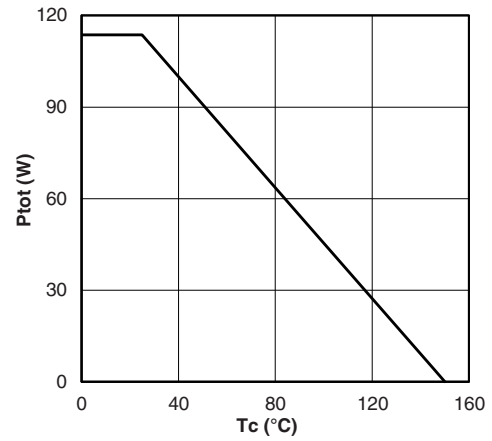


Fig. 12 - Power Dissipation vs. Case Temperature
(IGBT only)

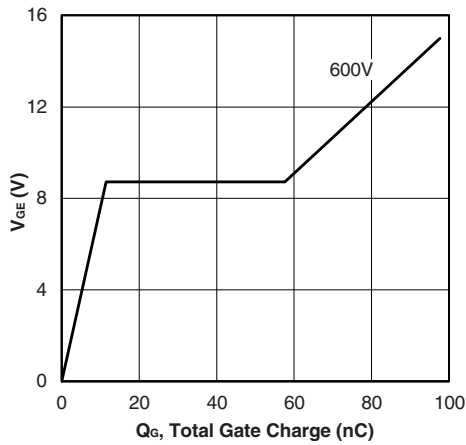


Fig. 10 - Typical Gate Charge vs. V_{GE}
 $I_{CE} = 15 \text{ A}$

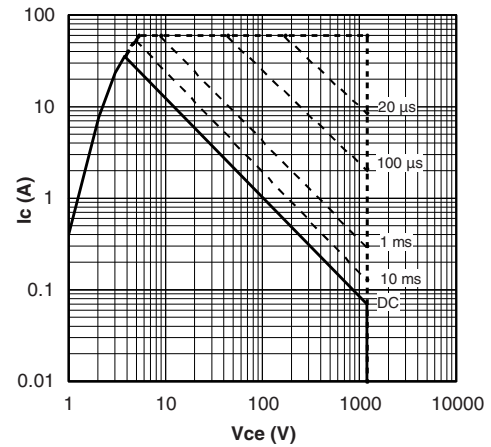


Fig. 13 - Forward SOA
 $T_C = 25^\circ\text{C}$, $T_J \leq 150^\circ\text{C}$

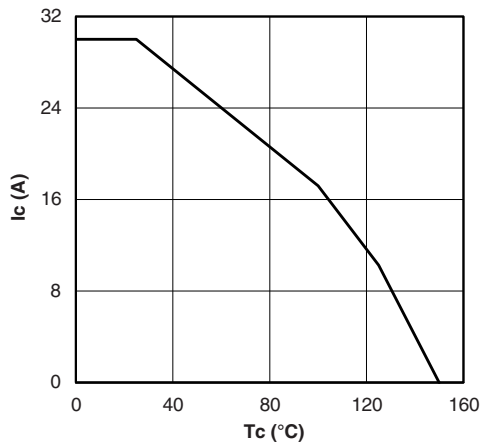


Fig. 11 - Maximum DC Collector Current vs.
Case Temperature

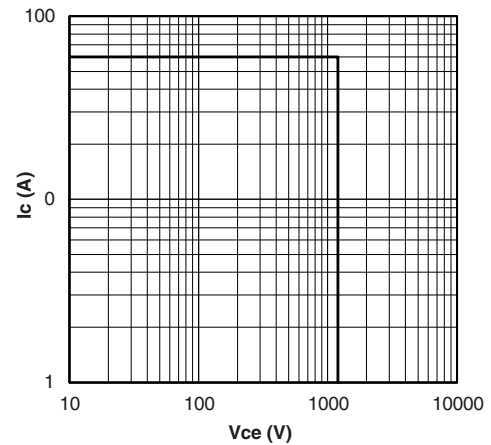


Fig. 14 - Reverse BIAS SOA
 $T_J = 150^\circ\text{C}$, $V_{GE} = 15 \text{ V}$

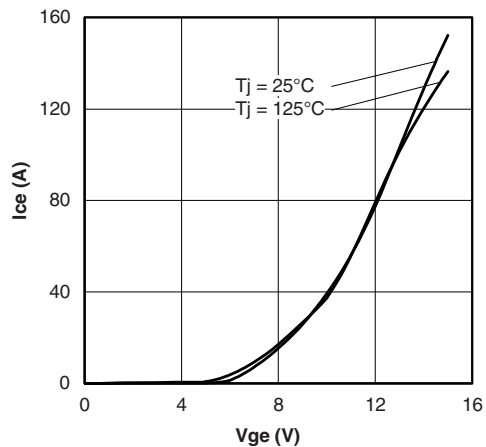


Fig. 15 - Typical Transfer Characteristics
 $V_{CE} = 50 \text{ V}$; $t_p = 10 \mu\text{s}$

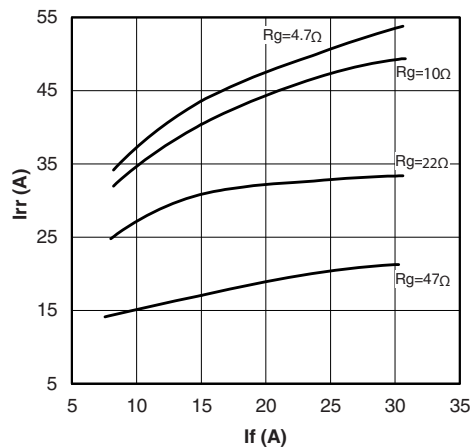


Fig. 17 - Typical Diode I_{rr} vs. I_F
 $T_J = 125^\circ\text{C}$

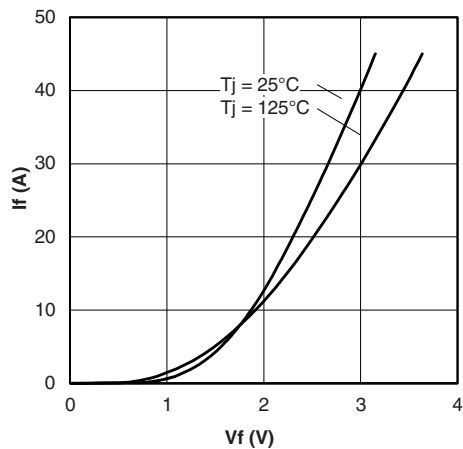


Fig. 16 - Typical Diode Forward Characteristics
 $t_p = 80 \mu\text{s}$

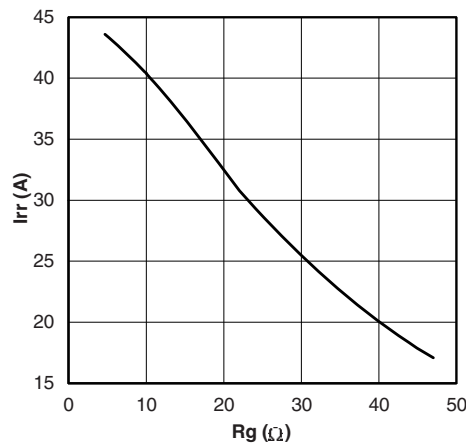


Fig. 18 - Typical Diode I_{rr} vs. R_g
 $T_J = 125^\circ\text{C}$; $I_F = 10 \text{ A}$

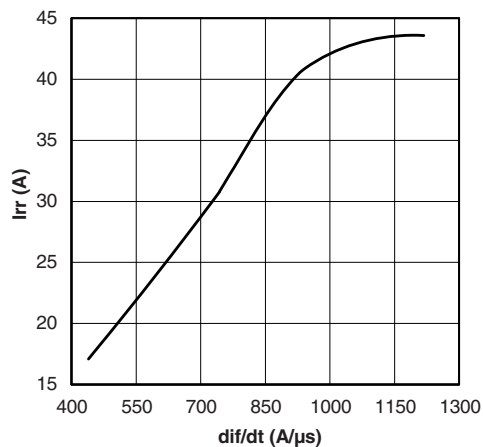


Fig. 19 - Typical Diode I_{rr} vs. dI_F/dt ; $V_{CC} = 600 \text{ V}$;
 $V_{GE} = 15 \text{ V}$; $I_{CE} = 10 \text{ A}$, $T_J = 125^\circ\text{C}$

Three Phase Inverter Module in MTP Package Vishay Semiconductors
1200 V NPT IGBT and HEXFRED® Diodes, 15 A

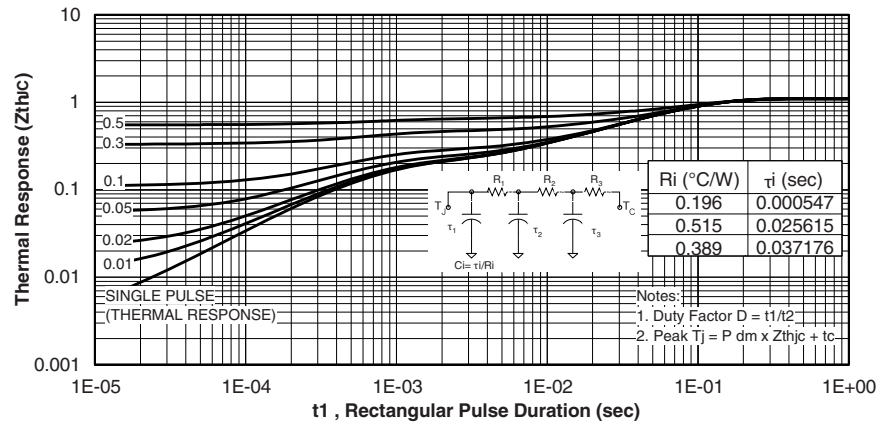


Fig. 20 - Maximum Transient Thermal Impedance, Junction to Case (IGBT)

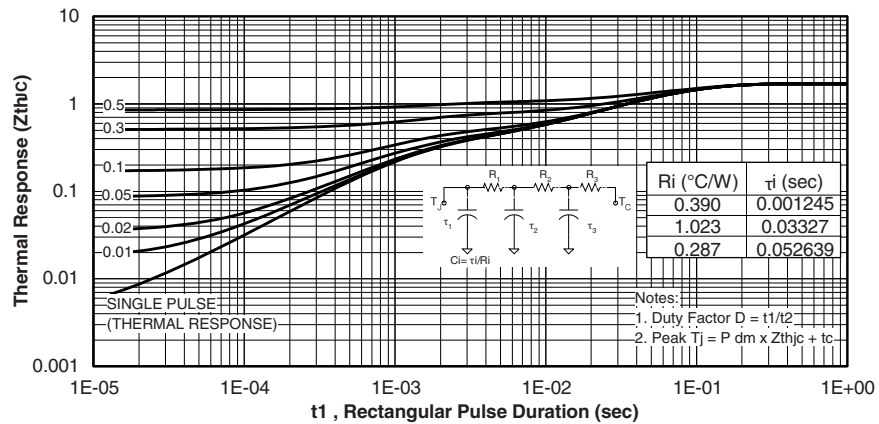


Fig. 21 - Maximum Transient Thermal Impedance, Junction to Case (Diode)

GB15XP120KTPbF

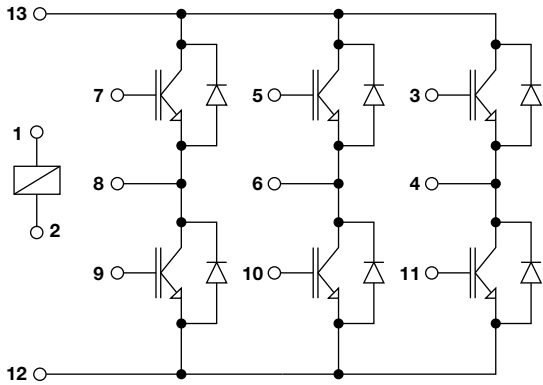


Vishay Semiconductors Three Phase Inverter Module in MTP Package
1200 V NPT IGBT and HEXFRED® Diodes, 15 A

ORDERING INFORMATION TABLE

Device code	GB	15	XP	120	K	T	PbF
	1	2	3	4	5	6	7
1							- IGBT module
2							- Nominal current rating (15 = 15 A)
3							- Circuit configuration (XP = Three phase inverter)
4							- Voltage code (120 = 1200 V)
5							- Speed/type (K = Ultrafast IGBT/inverter motor drive application)
6							- Special option: • None = No special option • T = Thermistor
7							- PbF = Lead (Pb)-free

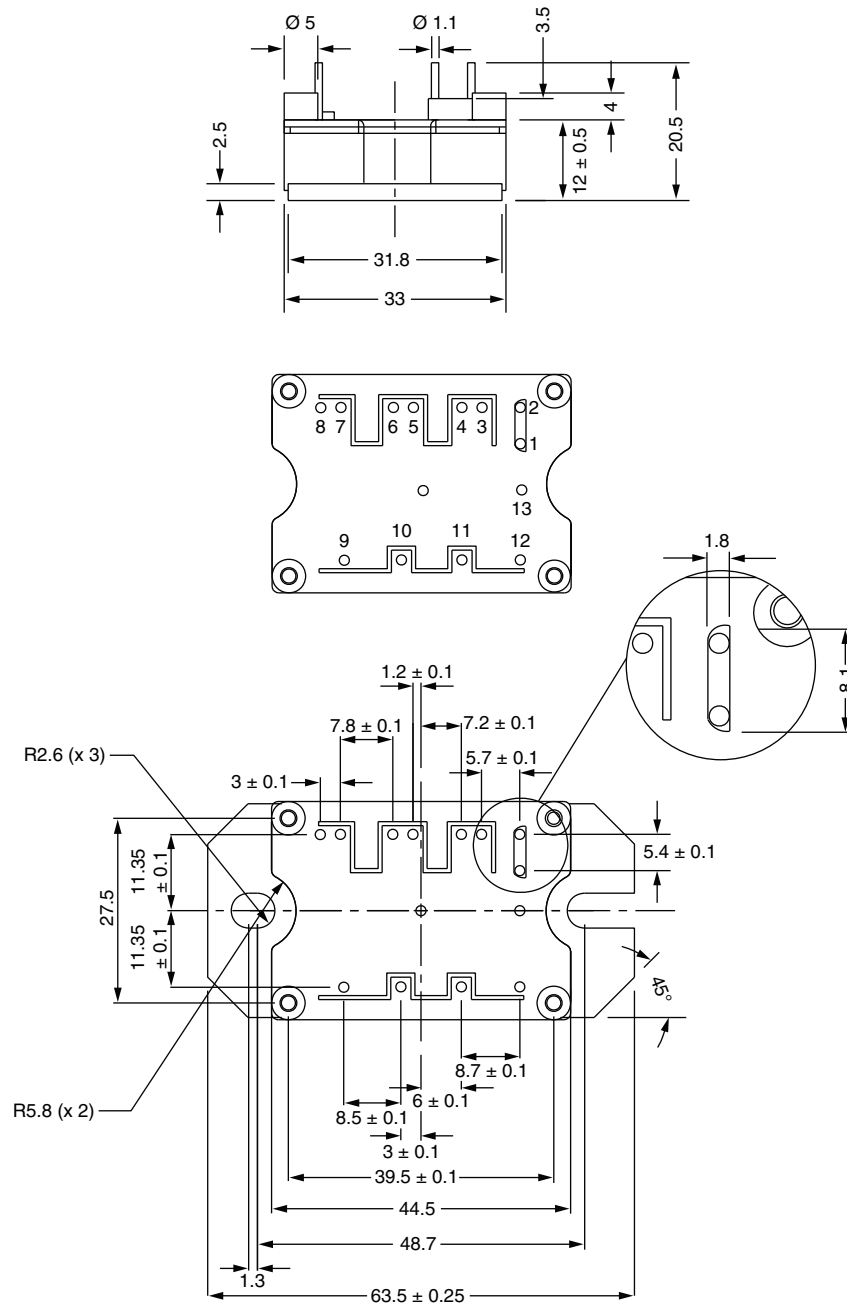
CIRCUIT CONFIGURATION



LINKS TO RELATED DOCUMENTS	
Dimensions	www.vishay.com/doc?95175

MTP

DIMENSIONS in millimeters



Note

- Unused terminals are not assembled in the package



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